AN48840B, AN48841B

Low current consumption, high sensitivity CMOS Hall IC

Alternating magnetic field operation (For low-speed rotation detection)

Overview

The AN48840B/AN48841B Series is a Hall ICs (a magnetic sensor) which has 2 times or more sensitivity and a low current consumption of about one fiftieth compared with our conventional one.

In this Hall IC, a Hall element, a offset cancel circuit, an amplifier circuit, a sample and hold circuit, a Schmidt circuit, and output stage FET are integrated on a single chip housed in a small package by IC technique.

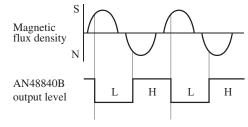
■ Features

- High sensitivity (AN48840B: 6 mT max., AN48841B: 8 mT max.) due to offset cancel circuit and a new sample and hold circuit
- Small current by using intermittent action
 (Average supply current: 56 μA typ., Sampling period: 670 μs typ.)
- Small package (SMD)
- CMOS inverter output (logic output form)

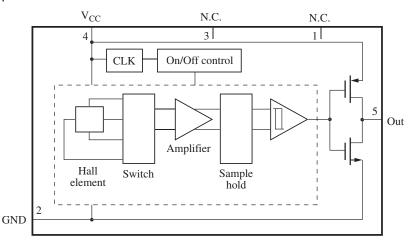
■ Applications

• Functional operation key, Mouse, Appliances for low-speed rotation detection

0.22*0.19 Unit: mm 0.22*0.19 (John 13.00) 1 2 3 (John 10) 2 3 (John 10) Seating plane SMINI-5DA (Lead-free package)



■ Block Diagram



■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	N.C.	_	4	V _{CC}	Power supply
2	GND	Ground	5	Out	Output
3	N.C.	_			

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	5	V
Output voltage	V _{OUT}	5	V
Supply current	I _{CC}	5	mA
Output current	I _{OUT}	15	mA
Power dissipation *1,*2	P_{D}	60	mW
Operating ambient temperature *1	T _{opr}	-25 to +75	°C
Storage temperature *1	T _{stg}	-55 to +125	°C

Note) *1: Except for the power dissipation, operating ambient temperature and storage temperature, all ratings are for T_x = 25°C.

■ Recommended Operating Range

Paramete	r	Symbol	Range	Unit
Supply voltage	AN48840B	V _{CC}	2.5 to 3.5	V
	AN48841B		2.5 to 5.25	

\blacksquare Electrical Characteristics $~T_a$ = $25^{\circ}C$ $\pm~2^{\circ}C$

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Operating magnetic flux density 1 *1	AN48840B	B_{HL}	$V_{CC} = 3 \text{ V}, V_{CC} = 2.5 \text{ V}$	0.5	_	6	mT
	AN48841B			0.5	_	8	mT
Operating magnetic	AN48840B	B_{LH}	$V_{CC} = 3 \text{ V}, V_{CC} = 2.5 \text{ V}$	-6	_	-0.5	mT
flux density 2 *2	AN48841B			-8	_	- 0.5	mT
Output voltage 1		V _{OL1}	$V_{CC} = 3 \text{ V, } I_O = 2 \text{ mA, B} = 6.0 \text{ mT}$	_	0.1	0.3	V
Output voltage 1		V _{OL2}	$V_{CC} = 2.5 \text{ V}, I_{O} = 2 \text{ mA}, B = 6.0 \text{ mT}$	_	0.1	0.3	V
Output voltage 2		V _{OH1}	$V_{CC} = 3 \text{ V}, I_{O} = -2 \text{ mA}, B = -6.0 \text{ mT}$	2.7	2.9	_	V
Output voltage 2		V _{OH2}	$V_{CC} = 2.5 \text{ V}, I_{O} = -2 \text{ mA}, B = -6.0 \text{ mT}$	2.7	2.9	_	V
Supply current 1 *3		I _{CCAVE}	$V_{CC} = 3 \text{ V}$	_	56.0	85.0	μΑ
Supply current 2 *3		I _{CC2AVE}	$V_{CC} = 2.5 \text{ V}$	_	48.0	72.0	μА
Intermittent action time		Tsam	$V_{CC} = 3 \text{ V}$	490	670	850	μS
Intermittent action time 2		Tsam2	$V_{CC} = 2.5 \text{ V}$	513	710	890	μS

Note) *1: Symbol B_{H-LS} , B_{H-LN} stands for the operating magnetic flux density where its output level varies from high to low.

• Design reference data

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Hysteresis width	BW	$V_{CC} = 3 V$	_	7	_	mT
Supply current 3	I _{CCON}	$V_{CC} = 3 \text{ V}$	_	1.4	2.1	mA
Supply current 4	I _{CCOFF}	$V_{CC} = 3 V$	_	2.5	_	μА
Supply current 5	I _{CC2ON}	$V_{CC} = 2.5 \text{ V}$	_	1.12	1.68	mA
Supply current 6	I _{CC2OFF}	$V_{CC} = 2.5 \text{ V}$	_	2.2	_	μА
Operating time	t _{ON}	$T_{a'} = -25$ °C to 75°C, $V_{CC} = 3$ V	10	26	42	μS
Stop time	t _{OFF}	$T_{ar} = -25$ °C to 75°C, $V_{CC} = 3$ V	258	644	1 030	μS
Operating time 2	t _{2ON}	$T_{ar} = -25$ °C to 75°C, $V_{CC} = 2.5$ V	11	27	43	μS
Stop time 2	t _{2OFF}	$T_{a'} = -25$ °C to 75°C, $V_{CC} = 2.5$ V	270	674	1 078	μS

Note) It will operate normally in approximately 0.67 ms after power on.

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 $^{*2:}T_d = 75^{\circ}C$. For the independent IC without a heat sink. Please use within the range of power dissipation, referring to $P_D - T_d$ curve.

 $^{*2:} Symbol\ B_{L-HS}\ ,\ B_{L-HN}\ stands\ for\ the\ operating\ magnetic\ flux\ density\ where\ its\ output\ level\ varies\ from\ low\ to\ high.$

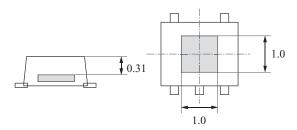
 $^{*3:} I_{CC_{AVE}} = \{I_{CC_{ON}} \times t_{ON} + I_{CC_{OFF}} \times t_{OFF}\} / \{t_{ON} + t_{OFF}\}$

■ Technical Data

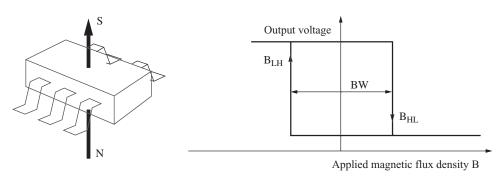
• Position of a Hall element (unit in mm)

Distance from a package surface to sensor part: 0.31 mm (reference value)

A Hall element is placed on the shaded part in the figure.



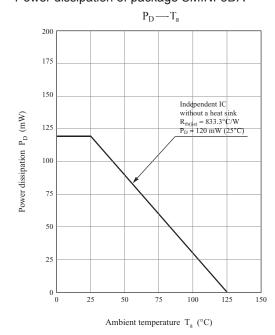
• Magneto-electro conversion characteristics



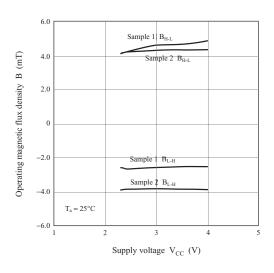
Direction of applied magnetic field

Operating magnetic flux density

• Power dissipation of package SMINI-5DA



AN48840B Main characterisitcs Operating magnetic flux density — Supply voltage

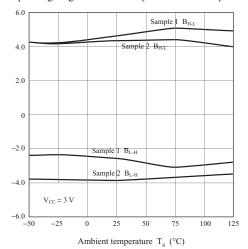


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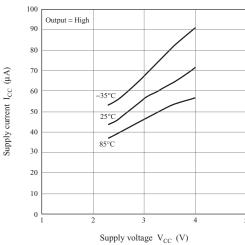
■ Technical Data (continued)

• AN48840B Main characterisitcs (continued)

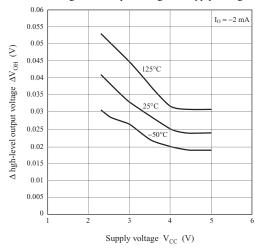
Operating magnetic flux density — Ambient temperature



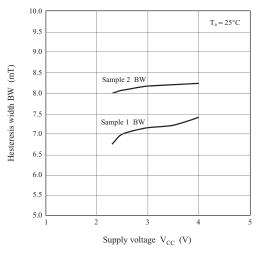
Supply current — Supply voltage



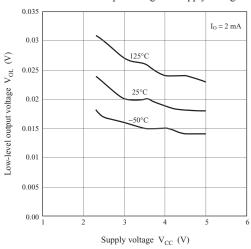
Δ high-level output voltage — Supply voltage



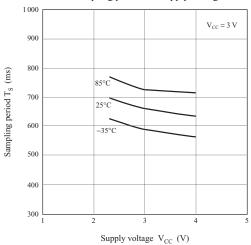
Hysteresis width — Supply voltage



Low-level output voltage - Supply voltage



Sampling period - Supply voltage



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